

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-60	V
Gate-Source Voltage (Note 5)	V <sub>GS</sub>	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	-2.1 -1.7	A
	T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	-6.1 -4.9	A
Maximum Body Diode Continuous Current	I <sub>S</sub>	-1.8	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-11	A
Single Pulsed Avalanche Current (Note 7) L = 0.1mH	I <sub>AS</sub>	-12	A
Single Pulsed Avalanche Energy (Note 7) L = 0.1mH	E <sub>AS</sub>	8	mJ

**Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	P <sub>D</sub>	1.8	W
		1.1	
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>θJA</sub>	69	°C/W
Total Power Dissipation (Note 6)	P <sub>D</sub>	14	W
Thermal Resistance, Junction to Case (Note 6)	R <sub>θJC</sub>	8.7	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS</b> (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-60	—	—	V	I <sub>D</sub> = -250µA, V <sub>GS</sub> = 0V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	-1	µA	V <sub>DS</sub> = -60V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	—	—	±100	nA	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V
<b>ON CHARACTERISTICS</b> (Note 8)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1	—	-3	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250µA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	128	250	mΩ	V <sub>GS</sub> = -10V, I <sub>D</sub> = -1.0A
			128	250		V <sub>GS</sub> = -10V, I <sub>D</sub> = -1.9A
			156	300		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -0.5A
			158	300		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1.5A
Diode Forward Voltage	V <sub>SD</sub>	—	—	-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -2.0A
<b>DYNAMIC CHARACTERISTICS</b> (Note 9)						
Input Capacitance	C <sub>iss</sub>	—	551	—	pF	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V f = 1MHz
Output Capacitance	C <sub>oss</sub>	—	25.7	—	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	—	19.1	—	pF	
Gate Resistance	R <sub>g</sub>	—	12.1	—	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Q <sub>g</sub>	—	4.8	—	nC	V <sub>DS</sub> = -30V, I <sub>D</sub> = -2A
Total Gate Charge (V <sub>GS</sub> = -10V)	Q <sub>g</sub>	—	9.7	—	nC	
Gate-Source Charge	Q <sub>gs</sub>	—	1.5	—	nC	
Gate-Drain Charge	Q <sub>gd</sub>	—	1.6	—	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	—	6.3	—	ns	V <sub>DS</sub> = -30V, V <sub>GS</sub> = -10V, R <sub>G</sub> = 50Ω, I <sub>D</sub> = -1A
Turn-On Rise Time	t <sub>r</sub>	—	10.3	—	ns	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	—	91.4	—	ns	
Turn-Off Fall Time	t <sub>f</sub>	—	39.8	—	ns	I <sub>S</sub> = -1A, di/dt = 100A/µs
Reverse Recovery Time	t <sub>RR</sub>	—	9.2	—	ns	
Reverse Recovery Charge	Q <sub>RR</sub>	—	3.9	—	nC	

- Notes:
5. AEC-Q101 V<sub>GS</sub> maximum is ±16V.
  6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
  7. I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep T<sub>J</sub> = +25°C.
  8. Short duration pulse test used to minimize self-heating effect.
  9. For design aid only, not subject to production testing.

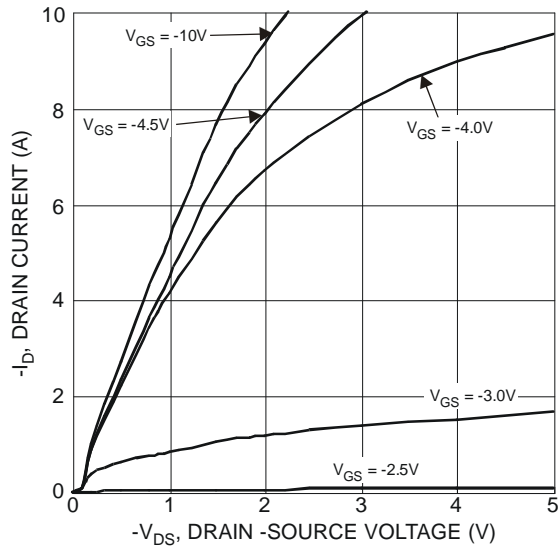


Figure 1 Typical Output Characteristics

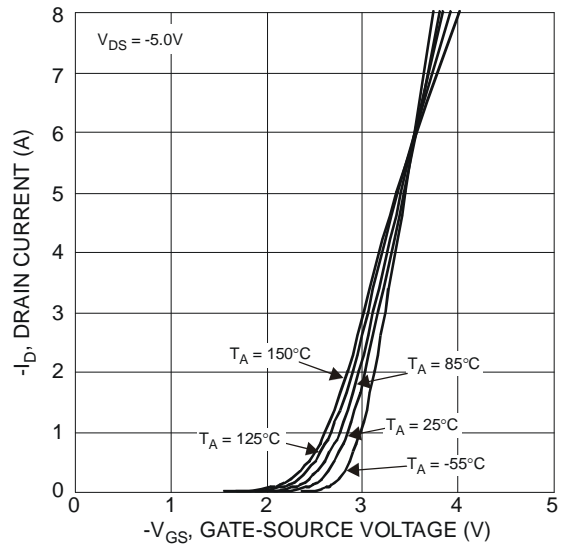


Figure 2 Typical Transfer Characteristics

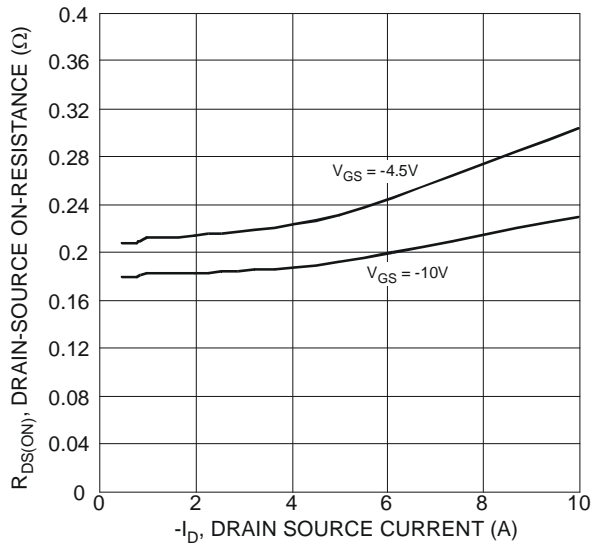


Figure 3 Typical On-Resistance vs. Drain Current and Gate Voltage

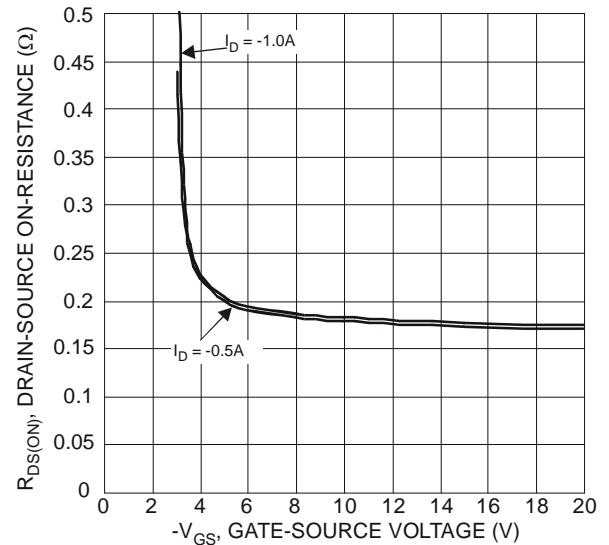


Figure 4 Typical Transfer Characteristics

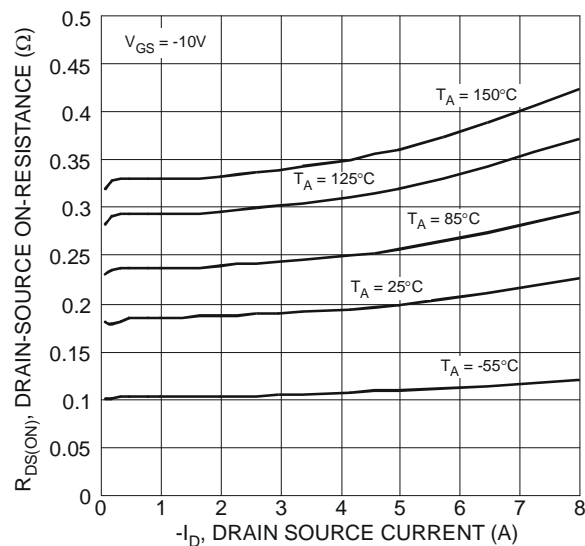


Figure 5 Typical On-Resistance vs. Drain Current and Temperature

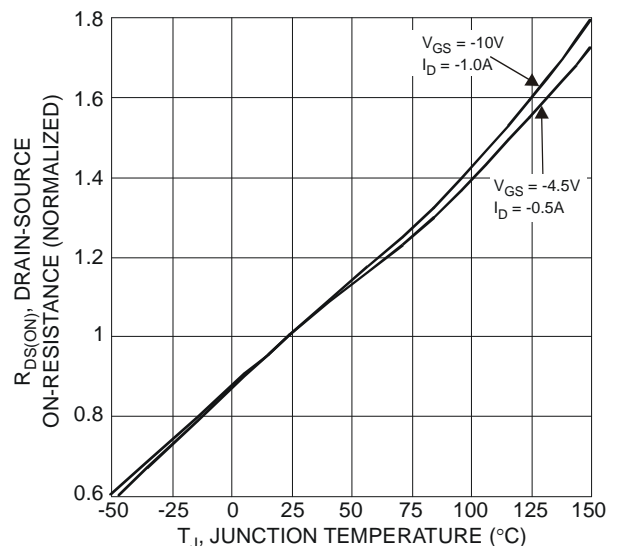
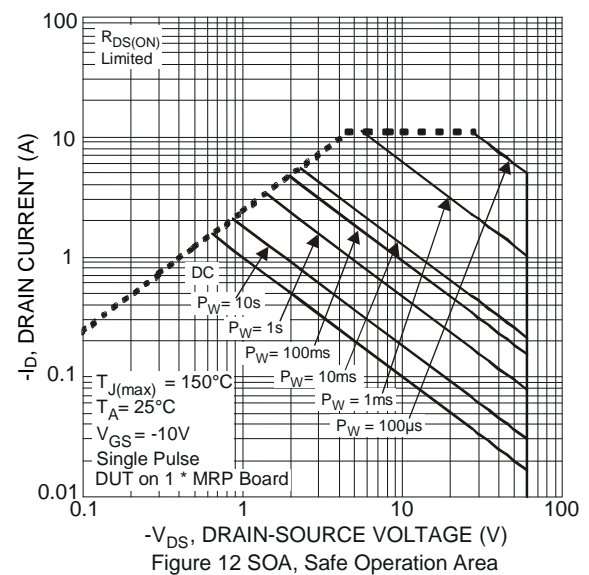
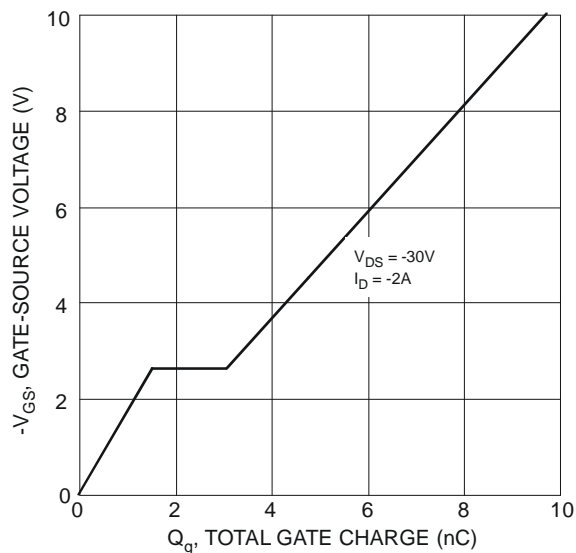
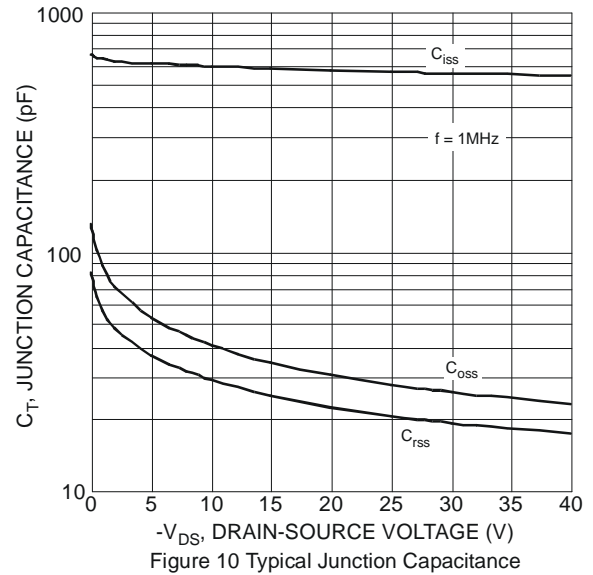
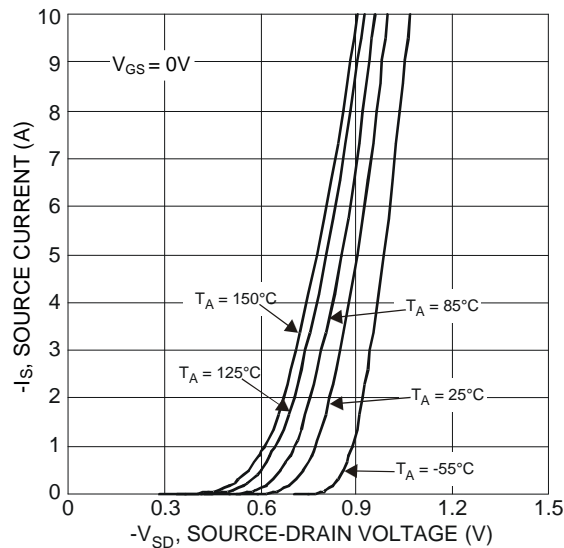
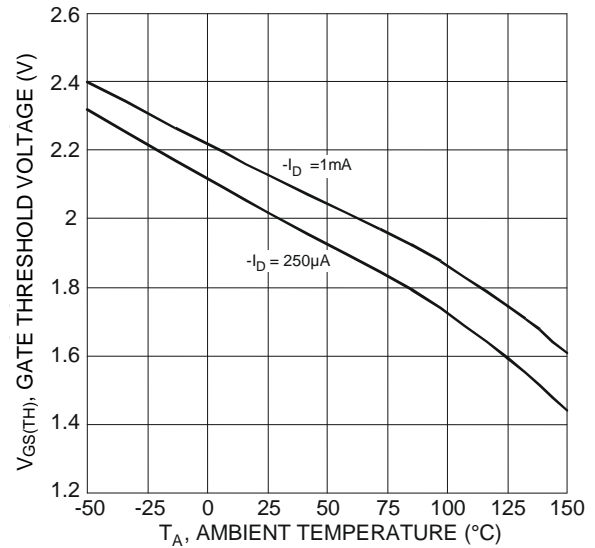
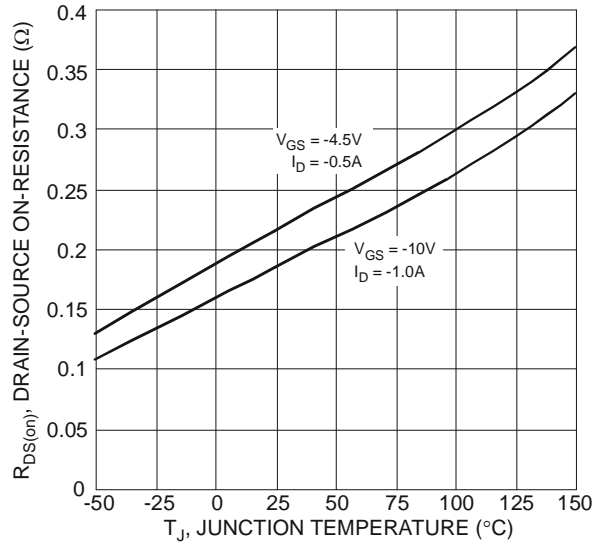
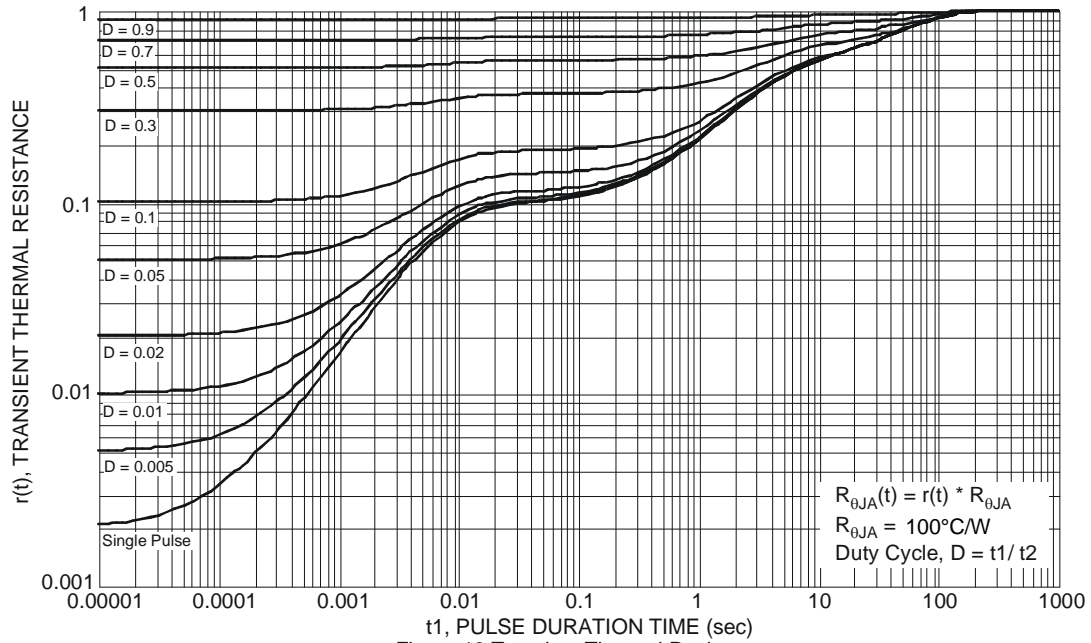


Figure 6 On-Resistance Variation with Temperature

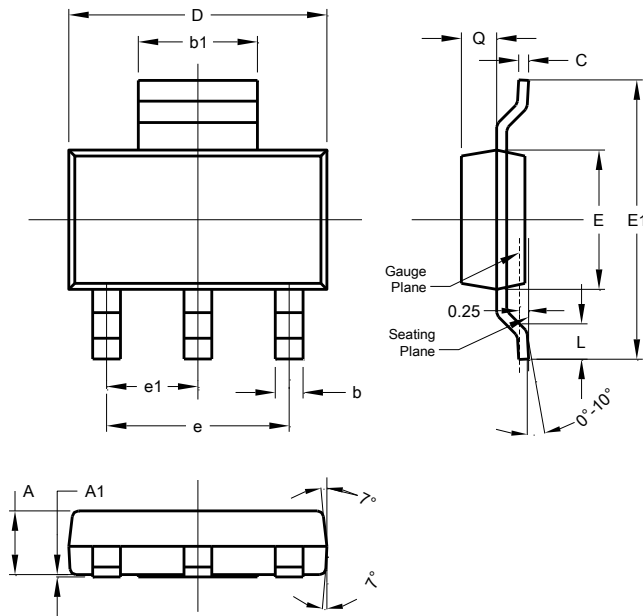




## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT223**

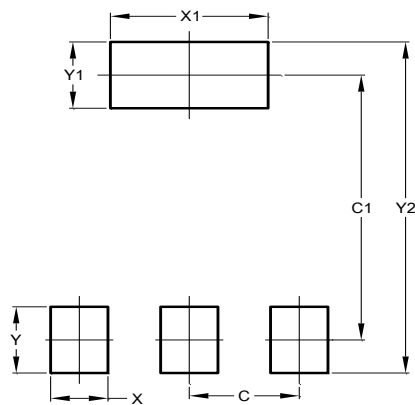


SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b	0.60	0.80	0.70
b1	2.90	3.10	3.00
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	-	-	4.60
e1	-	-	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT223**



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

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